



# PSMP061-60YE

60 V, P-channel Trench MOSFET

13 January 2021

Product data sheet

## 1. General description

P-channel enhancement mode MOSFET in an LFLPAK56 (Power SO8) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- High thermal power dissipation capability
- Suitable for thermally demanding environments due to 175 °C rating
- Trench MOSFET technology

## 3. Applications

- Reverse battery protection
- Power management
- High-side load switch
- Motor drive

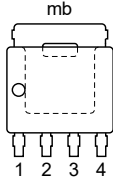
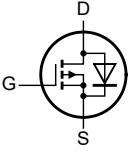
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DS}$	drain-source voltage	$T_j = 25\text{ °C}$	-	-	-60	V
$V_{GS}$	gate-source voltage		-20	-	20	V
$I_D$	drain current	$V_{GS} = -10\text{ V}; T_{mb} = 25\text{ °C}$	-	-	-25	A
$P_{tot}$	total power dissipation	$T_{mb} = 25\text{ °C}$	-	-	66	W
<b>Static characteristics</b>						
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = -10\text{ V}; I_D = -4.7\text{ A}; T_j = 25\text{ °C}$	-	48	61	mΩ

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	 <p><b>LFPAK56; Power-SO8 (SOT669)</b></p>	 <p>017aaa094</p>
2	S	source		
3	S	source		
4	G	gate		
mb	D	mounting base; connected to drain		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMP061-60YE	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	SOT669

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PSMP061-60YE	06160YE

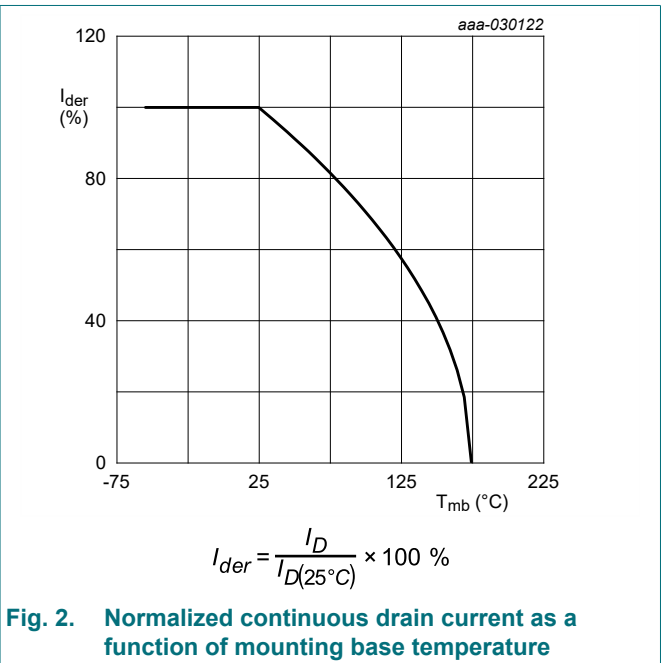
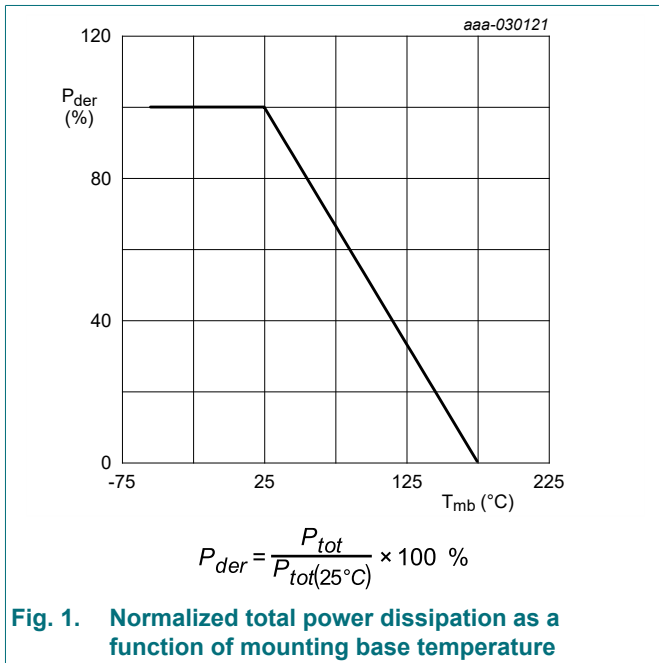
## 8. Limiting values

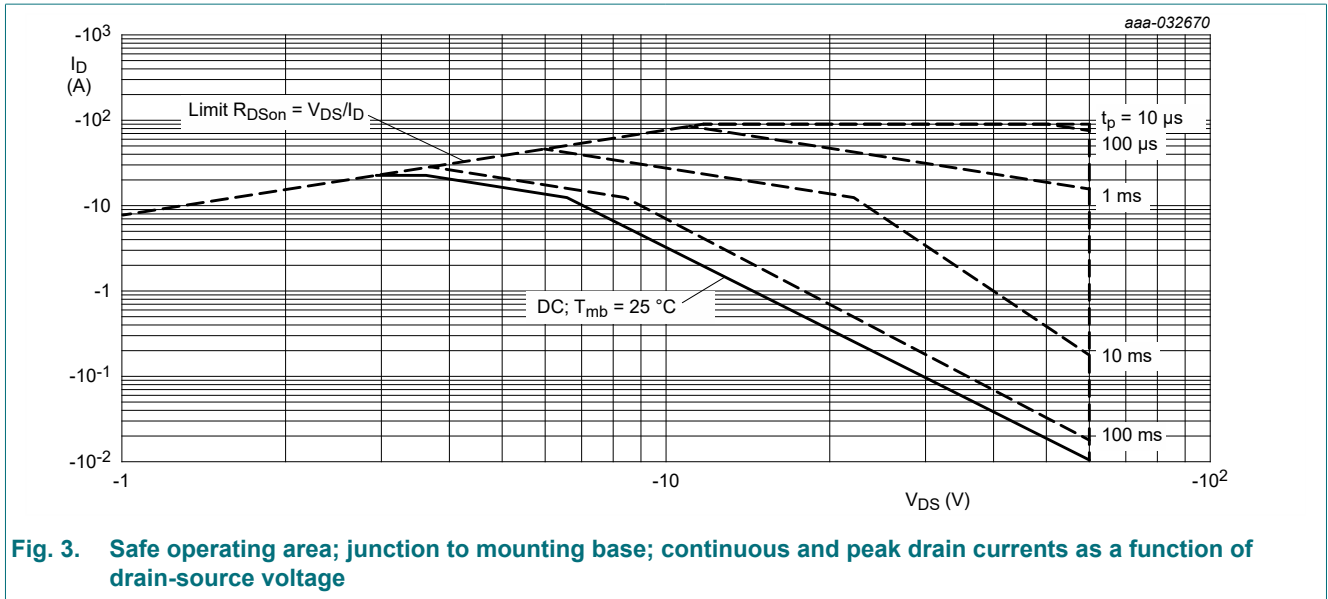
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C	-	-60	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>mb</sub> = 25 °C	-	-25	A
		V <sub>GS</sub> = -10 V; T <sub>mb</sub> = 100 °C	-	-17.7	A
I <sub>DM</sub>	peak drain current	single pulse; t <sub>p</sub> ≤ 10 μs; T <sub>mb</sub> = 25 °C	-	-90	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C	-	66	W
T <sub>j</sub>	junction temperature		-55	175	°C
T <sub>amb</sub>	ambient temperature		-55	175	°C
T <sub>stg</sub>	storage temperature		-65	175	°C
<b>Source-drain diode</b>					
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	-25	A
I <sub>SM</sub>	peak source current	single pulse; t <sub>p</sub> ≤ 10 μs; T <sub>mb</sub> = 25 °C	-	-90	A
<b>ESD maximum rating</b>					
V <sub>ESD</sub>	electrostatic discharge voltage	HBM	[1]	800	V
<b>Avalanche ruggedness</b>					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	T <sub>j(initial)</sub> = 25 °C; I <sub>D</sub> = -4.6 A; DUT in avalanche (unclamped)	-	61	mJ

[1] Measured between all pins.



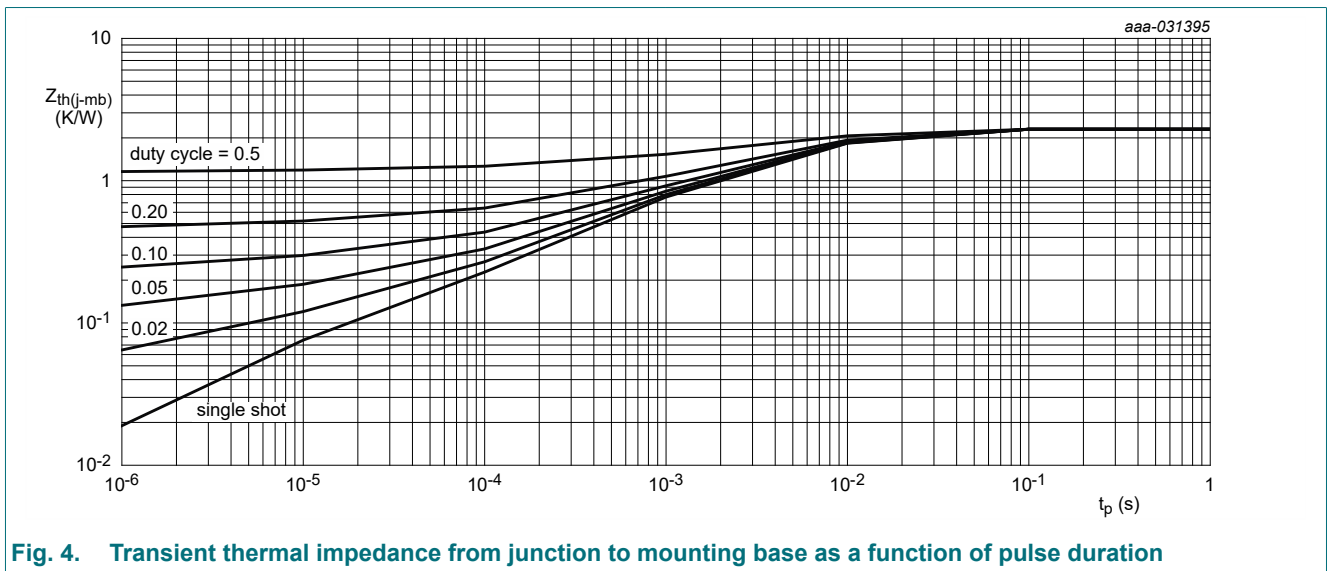


## 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	99	109	K/W
			[2]	-	47	52	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base			-	1.8	2.3	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = -250 \mu\text{A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-60	-	-	V
$V_{GSth}$	gate-source threshold voltage	$I_D = -250 \mu\text{A}; V_{DS}=V_{GS}; T_j = 25 \text{ }^\circ\text{C}$	-1.5	-2	-3	V
$I_{DSS}$	drain leakage current	$V_{DS} = -60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	-1	$\mu\text{A}$
		$V_{DS} = -60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$	-	-	-10	$\mu\text{A}$
$I_{GSS}$	gate leakage current	$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	-100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	100	nA
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = -10 \text{ V}; I_D = -4.7 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$	-	48	61	m $\Omega$
		$V_{GS} = -10 \text{ V}; I_D = -4.7 \text{ A}; T_j = 175 \text{ }^\circ\text{C}$	-	100	130	m $\Omega$
		$V_{GS} = -4.5 \text{ V}; I_D = -3.8 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$	-	62	93	m $\Omega$
$g_{fs}$	forward transconductance	$V_{DS} = -10 \text{ V}; I_D = -4 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$	-	65	-	S
$R_G$	gate resistance	$f = 1 \text{ MHz}; T_j = 25 \text{ }^\circ\text{C}$	-	12	-	$\Omega$
<b>Dynamic characteristics</b>						
$Q_{G(tot)}$	total gate charge	$V_{DS} = -30 \text{ V}; I_D = -4.7 \text{ A}; V_{GS} = -10 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	20	30	nC
$Q_{GS}$	gate-source charge		-	3.3	-	nC
$Q_{GD}$	gate-drain charge		-	4.3	-	nC
$C_{iss}$	input capacitance	$V_{DS} = -30 \text{ V}; f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	1060	-	pF
$C_{oss}$	output capacitance		-	85	-	pF
$C_{rss}$	reverse transfer capacitance		-	49	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = -30 \text{ V}; I_D = -4.7 \text{ A}; V_{GS} = -10 \text{ V}; R_{G(ext)} = 6 \text{ } \Omega; T_j = 25 \text{ }^\circ\text{C}$	-	12	-	ns
$t_r$	rise time		-	58	-	ns
$t_{d(off)}$	turn-off delay time		-	21	-	ns
$t_f$	fall time		-	204	-	ns
<b>Source-drain diode</b>						
$V_{SD}$	source-drain voltage	$I_S = -22.4 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-0.7	-1.2	V
$t_{rr}$	reverse recovery time	$I_S = -22.4 \text{ A}; dI_S/dt = 100 \text{ A}/\mu\text{s}; V_{GS} = -10 \text{ V}; V_{DS} = -30 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	30	-	ns
$Q_r$	recovered charge		-	37	-	nC

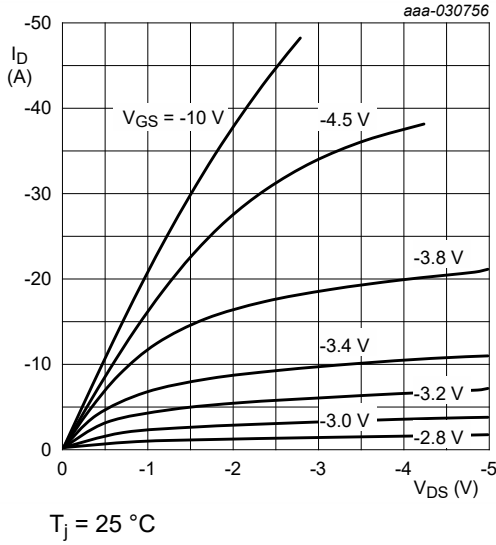


Fig. 5. Output characteristics: drain current as a function of drain-source voltage; typical values

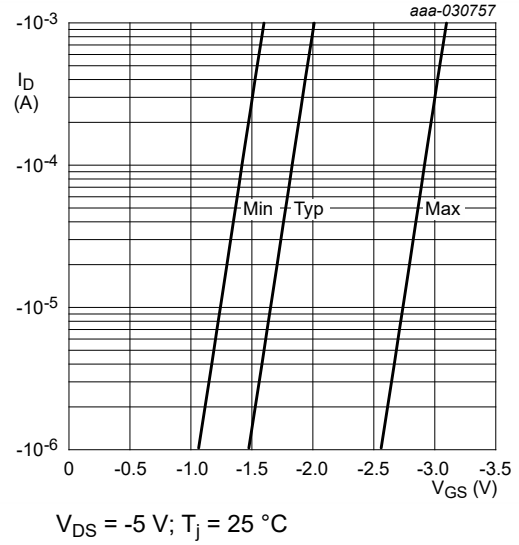


Fig. 6. Sub-threshold drain current as a function of gate-source voltage

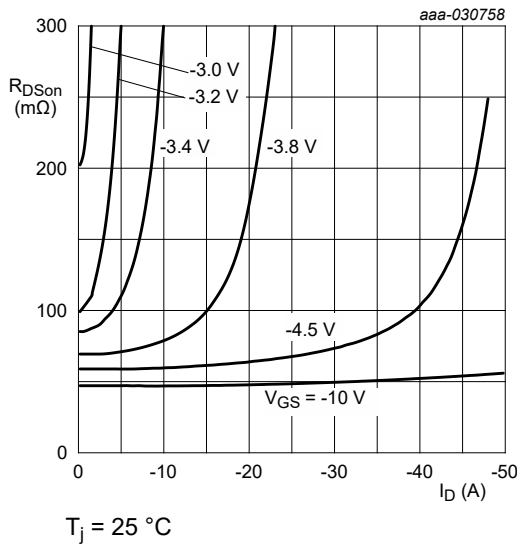


Fig. 7. Drain-source on-state resistance as a function of drain current; typical values

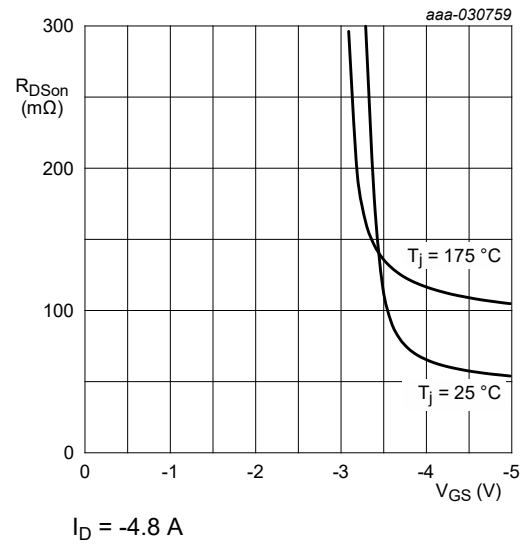


Fig. 8. Drain-source on-state resistance as a function of gate-source voltage; typical values

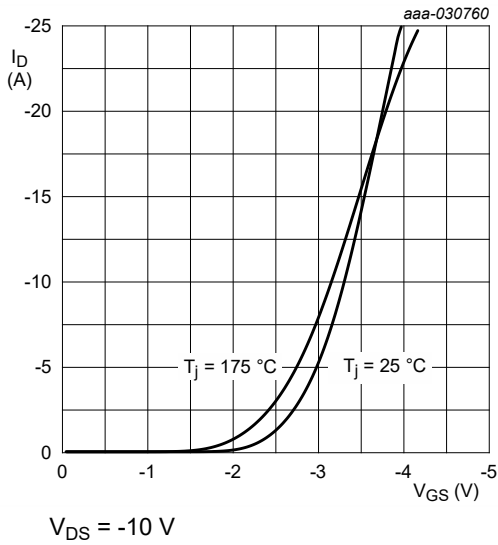
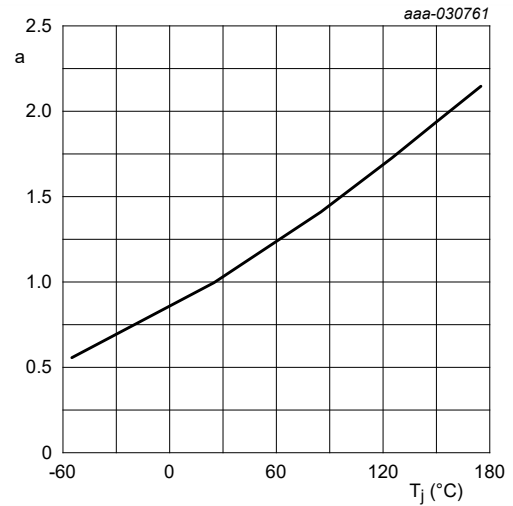
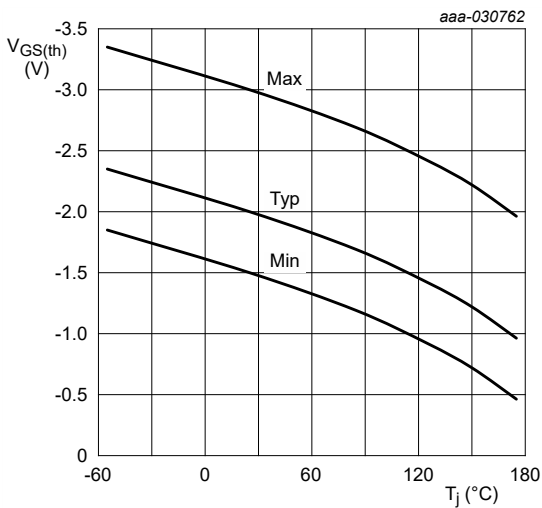


Fig. 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values



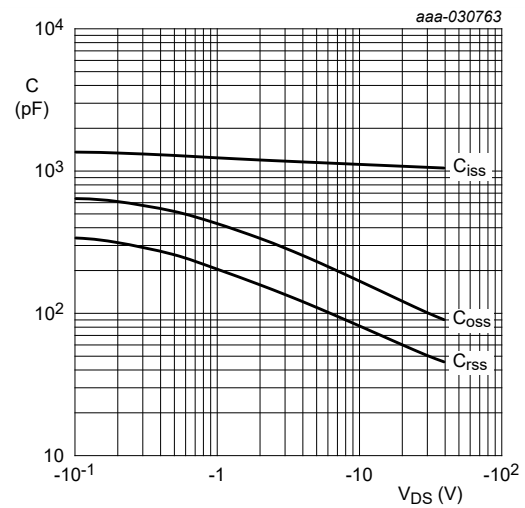
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ\text{C})}}$$

Fig. 10. Normalized drain-source on-state resistance as a function of junction temperature; typical values



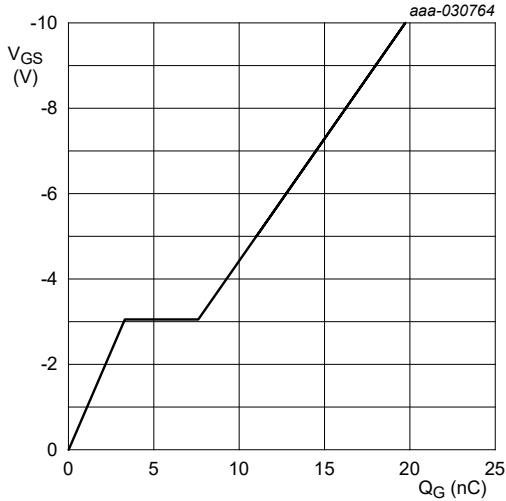
$I_D = -250\text{ }\mu\text{A}$ ;  $V_{DS} = V_{GS}$

Fig. 11. Gate-source threshold voltage as a function of junction temperature



$f = 1\text{ MHz}$ ;  $V_{GS} = 0\text{ V}$

Fig. 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{DS} = -30 \text{ V}; I_D = -4.8 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 13. Gate-source voltage as a function of gate charge; typical values

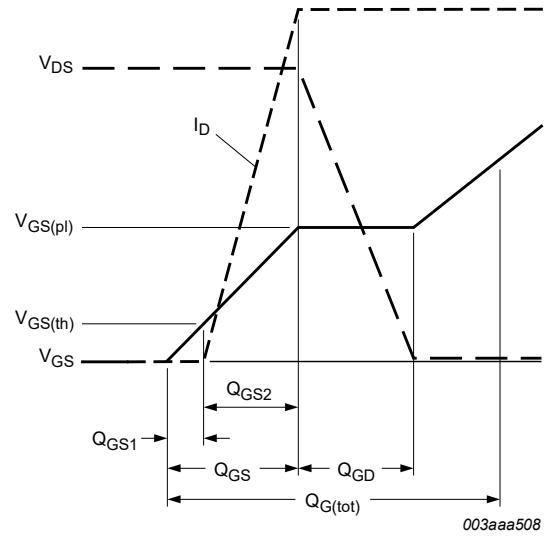
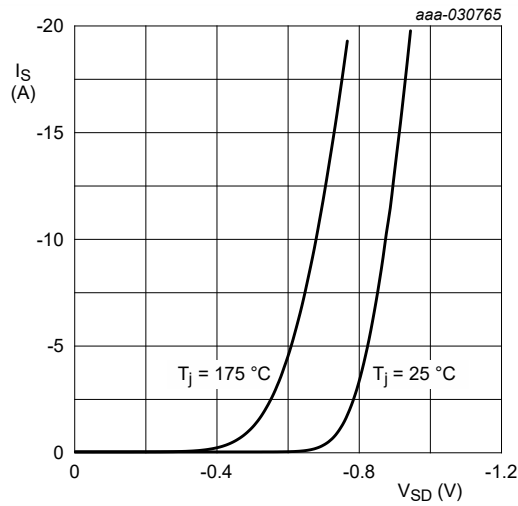


Fig. 14. Gate charge waveform definitions



$V_{GS} = 0 \text{ V}$

Fig. 15. Source current as a function of source-drain voltage; typical values



11. Test information

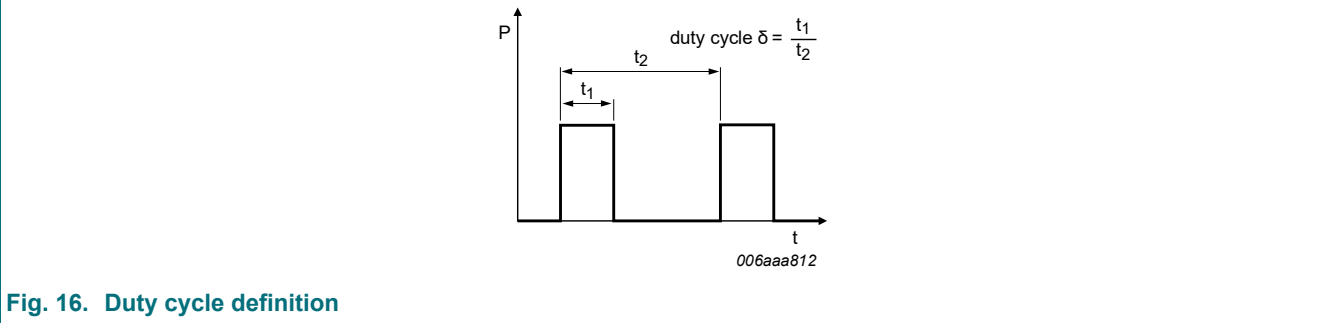


Fig. 16. Duty cycle definition

12. Package outline

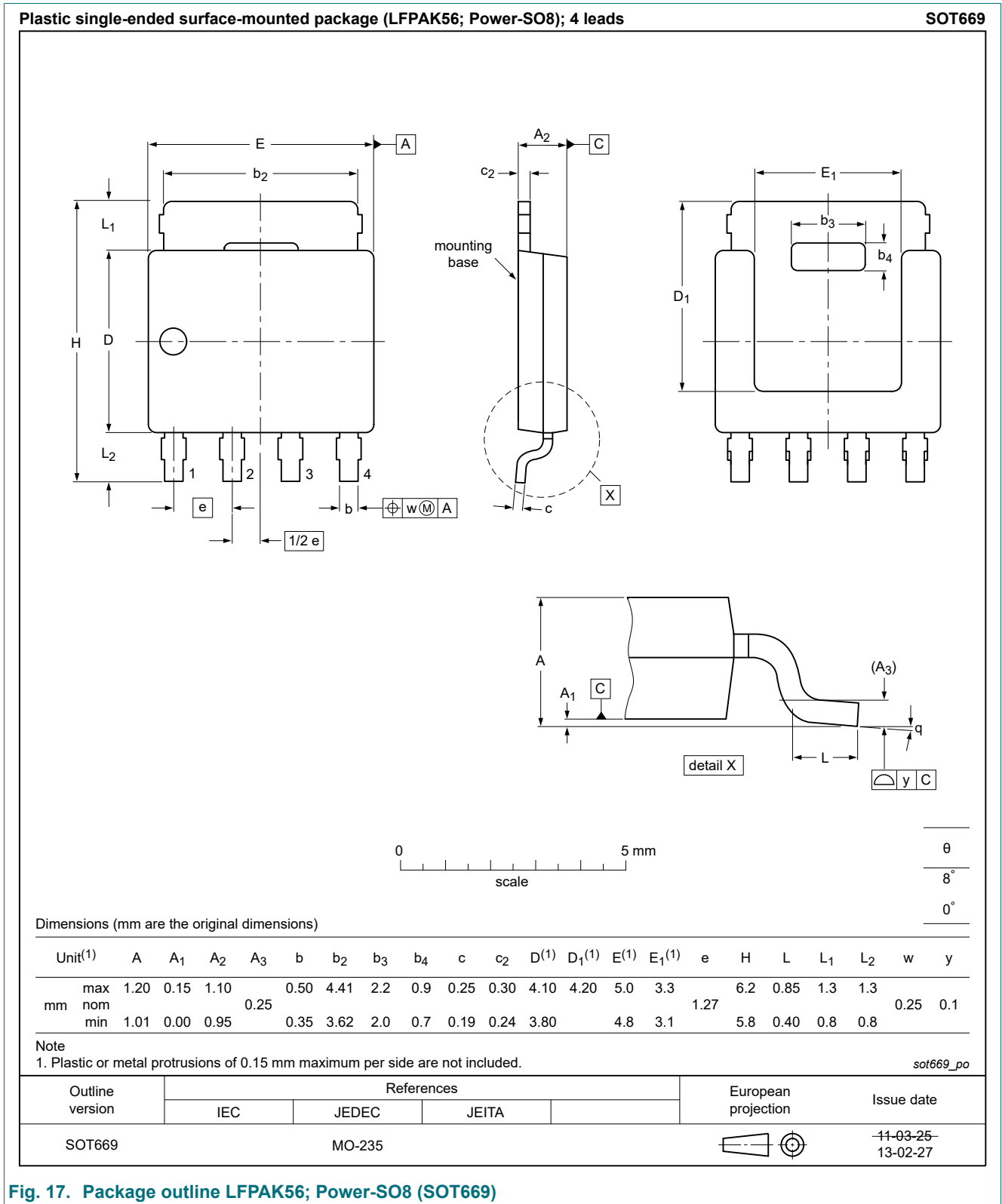


Fig. 17. Package outline LFPAK56; Power-SO8 (SOT669)

### 13. Soldering

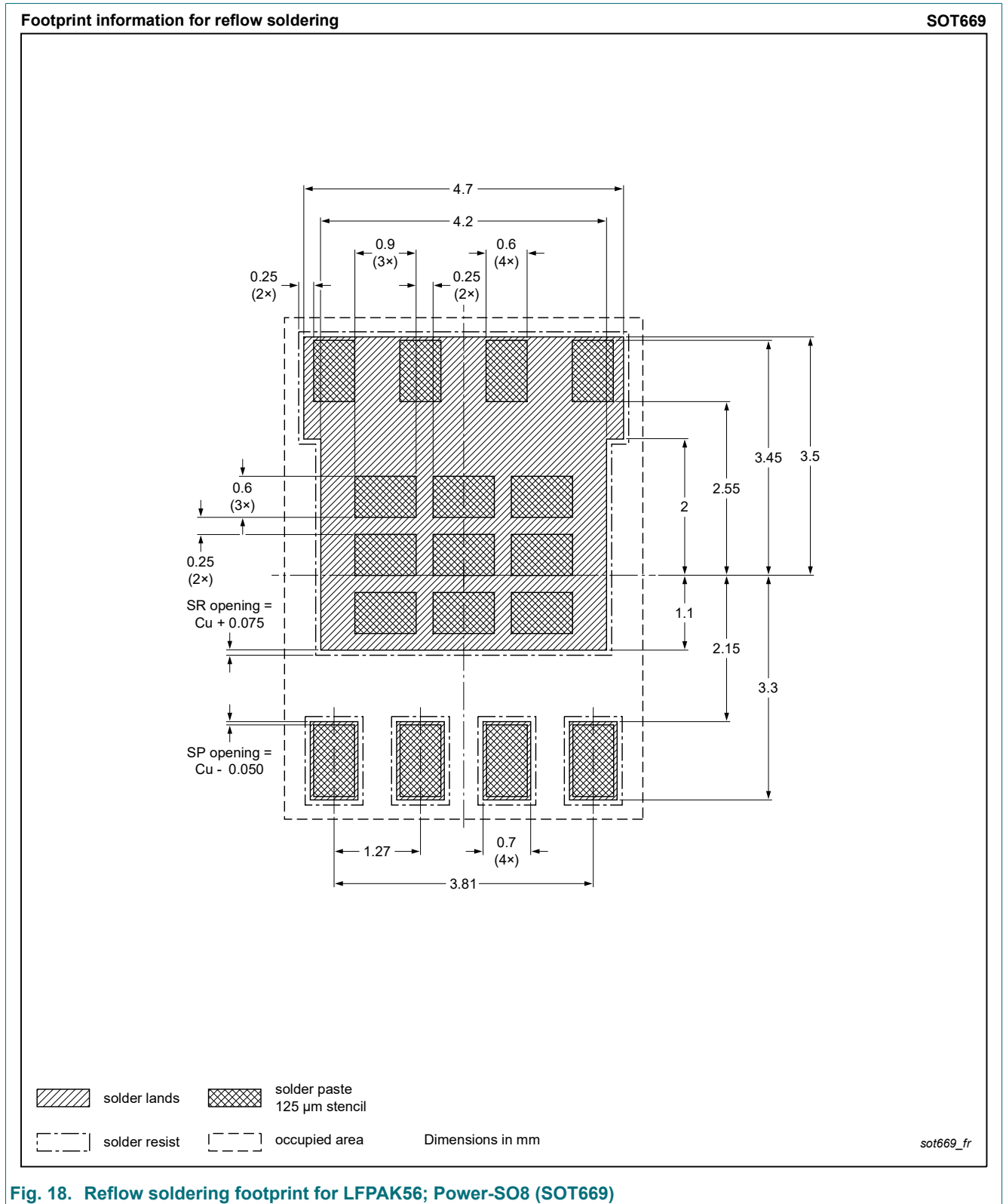
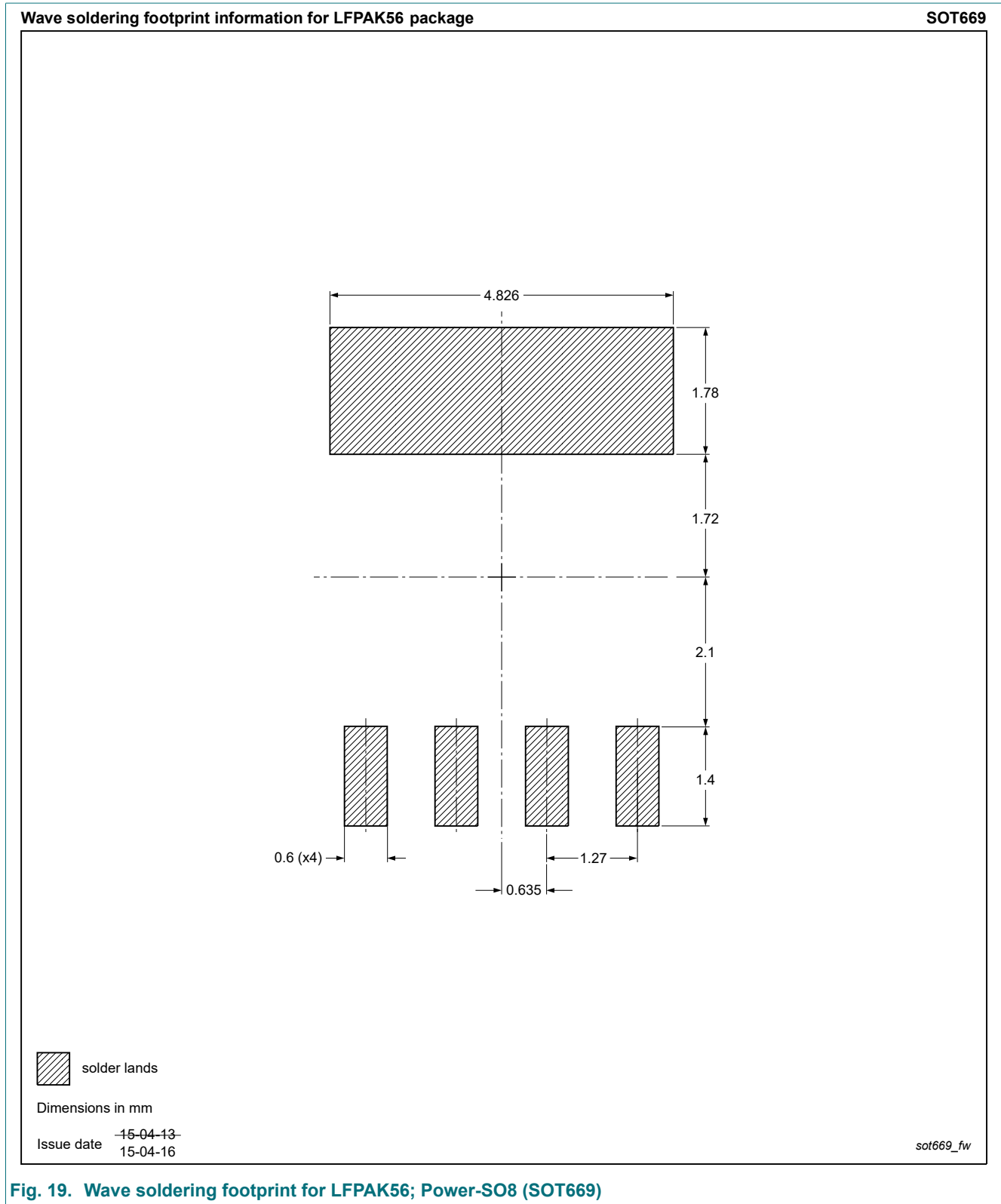


Fig. 18. Reflow soldering footprint for LFPAK56; Power-SO8 (SOT669)



## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PSMP061-60YE v.1	20210113	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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